

## SN74LV11A-Q1 汽车类三路 3 输入正与非门

### 1 特性

- 符合汽车应用要求
- 工作范围为 2V 至 5.5V  $V_{CC}$
- $V_{OLP}$  (输出接地反弹) 典型值小于 0.8V ( $V_{CC} = 3.3V$ ,  $T_A = 25^\circ C$ )
- $V_{OHV}$  (输出  $V_{OH}$  下冲) 典型值大于 2.3V ( $V_{CC} = 3.3V$ ,  $T_A = 25^\circ C$  时)
- 所有端口上均支持以混合模式电压运行
- $I_{off}$  支持局部关断模式运行

### 2 说明

这些三路 3 输入正与非门可在 2V 至 5.5V  $V_{CC}$  电压下运行。

SN74LV11A-Q1 器件以正逻辑执行布尔函数  $Y = A \cdot B \cdot C$  or  $Y = \overline{A + B + C}$ 。

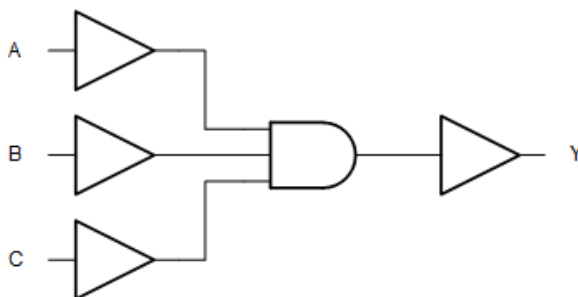
这些器件专用于使用  $I_{off}$  的局部断电应用。 $I_{off}$  电路禁用输出，从而可防止其断电时破坏性电流从该器件回流。

#### 封装信息

| 器件型号         | 封装 <sup>1</sup>   | 封装尺寸 <sup>2</sup> |
|--------------|-------------------|-------------------|
| SN74LV11A-Q1 | PW ( TSSOP , 14 ) | 5.00 mm x 6.4 mm  |

(1) 如需了解所有可用封装，请参阅数据表末尾的可订购产品附录。

(2) 封装尺寸 ( 长 x 宽 ) 为标称值，并包括引脚 ( 如适用 )。



简化原理图



## Table of Contents

|                                                                               |          |                                                                |          |
|-------------------------------------------------------------------------------|----------|----------------------------------------------------------------|----------|
| <b>1 特性</b> .....                                                             | <b>1</b> | 5.10 Operating Characteristics.....                            | <b>6</b> |
| <b>2 说明</b> .....                                                             | <b>1</b> | <b>6 Parameter Measurement Information</b> .....               | <b>7</b> |
| <b>3 Revision History</b> .....                                               | <b>2</b> | <b>7 Detailed Description</b> .....                            | <b>8</b> |
| <b>4 Pin Configuration and Functions</b> .....                                | <b>3</b> | 7.1 Overview.....                                              | 8        |
| <b>5 Specifications</b> .....                                                 | <b>4</b> | 7.2 Functional Block Diagram.....                              | 8        |
| 5.1 Absolute Maximum Ratings.....                                             | 4        | 7.3 Device Functional Modes.....                               | 8        |
| 5.2 ESD Ratings.....                                                          | 4        | <b>8 Device and Documentation Support</b> .....                | <b>9</b> |
| 5.3 Recommended Operating Conditions .....                                    | 4        | 8.1 Documentation Support (Analog).....                        | 9        |
| 5.4 Thermal Information.....                                                  | 5        | 8.2 接收文档更新通知.....                                              | 9        |
| 5.5 Electrical Characteristics.....                                           | 5        | 8.3 支持资源.....                                                  | 9        |
| 5.6 Switching Characteristics, $V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$ ..... | 5        | 8.4 Trademarks.....                                            | 9        |
| 5.7 Switching Characteristics, $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ ..... | 5        | 8.5 静电放电警告.....                                                | 9        |
| 5.8 Switching Characteristics, $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$ .....   | 6        | 8.6 术语表.....                                                   | 9        |
| 5.9 Noise Characteristics.....                                                | 6        | <b>9 Mechanical, Packaging, and Orderable Information</b> .... | <b>9</b> |

## 3 Revision History

注：以前版本的页码可能与当前版本的页码不同

### Changes from Revision D (May 2023) to Revision E (July 2023)

Page

- 添加了封装信息表、引脚功能表、ESD 等级表、热信息表、器件功能模式、器件和文档支持部分以及机械、封装和可订购信息部分..... **1**

## 4 Pin Configuration and Functions

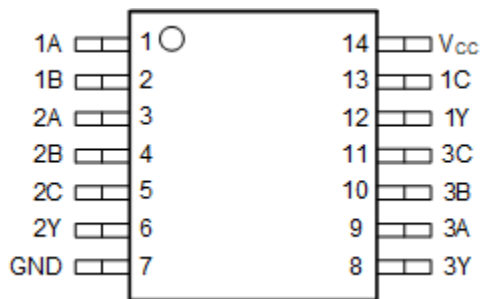


图 4-1. SN74LV11A-Q1 PW Package (Top View)

| PIN             |     | TYPE <sup>(1)</sup> | DESCRIPTION |
|-----------------|-----|---------------------|-------------|
| NAME            | NO. |                     |             |
| 1A              | 1   | I                   | 1A Input    |
| 1B              | 2   | I                   | 1B Input    |
| 2A              | 3   | I                   | 2A Input    |
| 2B              | 4   | I                   | 2B Input    |
| 2C              | 5   | I                   | 2C Input    |
| 2Y              | 6   | O                   | 2Y Output   |
| 3Y              | 8   | O                   | 3Y Output   |
| 3A              | 9   | I                   | 3A Input    |
| 3B              | 10  | I                   | 3B Input    |
| 3C              | 11  | I                   | 3C Input    |
| 1Y              | 12  | O                   | 1Y Output   |
| 1C              | 13  | I                   | 1C Input    |
| GND             | 7   | —                   | Ground Pin  |
| V <sub>CC</sub> | 14  | —                   | Power Pin   |

(1) Signal Types: I = Input, O = Output.

## 5 Specifications

### 5.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                  |                                                                      | MIN   | MAX                   | UNIT |
|------------------|----------------------------------------------------------------------|-------|-----------------------|------|
| V <sub>CC</sub>  | Supply voltage range                                                 | - 0.5 | 7                     | V    |
| V <sub>I</sub>   | Input voltage range <sup>(2)</sup>                                   | - 0.5 | 7                     | V    |
| V <sub>O</sub>   | Output voltage range applied in high or low state <sup>(2) (3)</sup> | - 0.5 | V <sub>CC</sub> + 0.5 | V    |
| V <sub>O</sub>   | Output voltage range applied in power-off state <sup>(2)</sup>       | - 0.5 | 7                     | V    |
| I <sub>IK</sub>  | Input clamp current (V <sub>I</sub> < 0)                             |       | - 20                  | mA   |
| I <sub>OK</sub>  | Output clamp current (V <sub>O</sub> < 0)                            |       | - 50                  | mA   |
| I <sub>O</sub>   | Continuous output current (V <sub>O</sub> = 0 to V <sub>CC</sub> )   |       | ±25                   | mA   |
|                  | Continuous current through V <sub>CC</sub> or GND                    |       | ±50                   | mA   |
| T <sub>stg</sub> | Storage temperature                                                  | - 65  | 150                   | °C   |

- (1) Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under *recommended operating conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) This value is limited to 5.5 V maximum.

### 5.2 ESD Ratings

|                    |                                                                                           | VALUE  | UNIT |
|--------------------|-------------------------------------------------------------------------------------------|--------|------|
| V <sub>(ESD)</sub> | Electrostatic discharge Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup> | ± 2000 | V    |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

### 5.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                 |                           | MIN                              | MAX                   | UNIT |
|-----------------|---------------------------|----------------------------------|-----------------------|------|
| V <sub>CC</sub> | Supply voltage            | 2                                | 5.5                   | V    |
| V <sub>IH</sub> | High level input voltage  | V <sub>CC</sub> = 2 V            | 1.5                   | V    |
|                 |                           | V <sub>CC</sub> = 2.3 V to 2.7 V | V <sub>CC</sub> × 0.7 |      |
|                 |                           | V <sub>CC</sub> = 3 V to 3.6 V   | V <sub>CC</sub> × 0.7 |      |
|                 |                           | V <sub>CC</sub> = 4.5 V to 5.5 V | V <sub>CC</sub> × 0.7 |      |
| V <sub>IL</sub> | Low level input voltage   | V <sub>CC</sub> = 2 V            | 0.5                   | V    |
|                 |                           | V <sub>CC</sub> = 2.3 V to 2.7 V | V <sub>CC</sub> × 0.3 |      |
|                 |                           | V <sub>CC</sub> = 3 V to 3.6 V   | V <sub>CC</sub> × 0.3 |      |
|                 |                           | V <sub>CC</sub> = 4.5 V to 5.5 V | V <sub>CC</sub> × 0.3 |      |
| V <sub>I</sub>  | Input voltage             | 0                                | 5.5                   | V    |
| V <sub>O</sub>  | Output voltage            | 0                                | V <sub>CC</sub>       | V    |
| I <sub>OH</sub> | High level output current | V <sub>CC</sub> = 2 V            | - 50                  | μA   |
|                 |                           | V <sub>CC</sub> = 2.3 V to 2.7 V | - 2                   | mA   |
|                 |                           | V <sub>CC</sub> = 3 V to 3.6 V   | - 6                   |      |
|                 |                           | V <sub>CC</sub> = 4.5 V to 5.5 V | - 12                  |      |
| I <sub>OL</sub> | Low level output current  | V <sub>CC</sub> = 2 V            | 50                    | μA   |
|                 |                           | V <sub>CC</sub> = 2.3 V to 2.7 V | 2                     | mA   |
|                 |                           | V <sub>CC</sub> = 3 V to 3.6 V   | 6                     |      |
|                 |                           | V <sub>CC</sub> = 4.5 V to 5.5 V | 12                    |      |

### 5.3 Recommended Operating Conditions (continued)

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                                                           |                                            | MIN  | MAX | UNIT |
|-----------------------------------------------------------|--------------------------------------------|------|-----|------|
| $\Delta t / \Delta v$ Input transition rise and fall rate | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ |      | 200 | ns/V |
|                                                           | $V_{CC} = 3 \text{ V to } 3.6 \text{ V}$   |      | 100 |      |
|                                                           | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ |      | 20  |      |
| $T_A$ Operating free-air temperature                      |                                            | - 40 | 105 | °C   |

(1) All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number [SCBA004](#)

### 5.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup>                          |  | SN74LV11A-Q1 | UNIT |
|--------------------------------------------------------|--|--------------|------|
|                                                        |  | PW           |      |
|                                                        |  | 14 PINS      |      |
| $R_{\theta JA}$ Junction-to-ambient thermal resistance |  | 113          | °C/W |

(1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report ([SPRA953](#)).

### 5.5 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER                           | TEST CONDITIONS                              | $V_{CC}$     | MIN            | TYP | MAX     | UNIT    |
|-------------------------------------|----------------------------------------------|--------------|----------------|-----|---------|---------|
| $V_{OH}$ High-level output voltage  | $I_{OH} = -50 \mu A$                         | 2 V to 5.5 V | $V_{CC} - 0.1$ |     |         | V       |
|                                     | $I_{OH} = -2 \text{ mA}$                     | 2.3 V        | 2              |     |         |         |
|                                     | $I_{OH} = -6 \text{ mA}$                     | 3 V          | 2.48           |     |         |         |
|                                     | $I_{OH} = -12 \text{ mA}$                    | 4.5 V        | 3.8            |     |         |         |
| $V_{OL}$ Low-level output voltage   | $I_{OL} = 50 \mu A$                          | 2 V to 5.5 V |                |     | 0.1     | V       |
|                                     | $I_{OL} = 2 \text{ mA}$                      | 2.3 V        |                |     | 0.4     |         |
|                                     | $I_{OL} = 6 \text{ mA}$                      | 3 V          |                |     | 0.44    |         |
|                                     | $I_{OL} = 12 \text{ mA}$                     | 4.5 V        |                |     | 0.55    |         |
| $I_I$ Input leakage current         | $V_I = 5.5 \text{ V or GND}$                 | 0 to 5.5 V   |                |     | $\pm 1$ | $\mu A$ |
| $I_{CC}$ Supply current             | $V_I = V_{CC}$<br>or GND, $I_O = 0$          | 5.5 V        |                |     | 20      | $\mu A$ |
| $I_{off}$ Off-state leakage current | $V_I$ or $V_O = 0 \text{ to } 5.5 \text{ V}$ | 0 V          |                |     | 5       | $\mu A$ |
| $C_i$ Input capacitance             | $V_I = V_{CC}$ or GND                        | 3.3 V        |                | 1.9 |         | pF      |

### 5.6 Switching Characteristics, $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$

over recommended operating free-air temperature range (unless otherwise noted) (see [Load Circuit and Voltage Waveforms](#))

| PARAMETER | FROM<br>(INPUT) | TO<br>(OUTPUT) | LOAD<br>CAPACITANCE   | $T_A = 25^\circ C$ |     |      | SN74LV11A-Q1 |     | UNIT |
|-----------|-----------------|----------------|-----------------------|--------------------|-----|------|--------------|-----|------|
|           |                 |                |                       | MIN                | TYP | MAX  | MIN          | MAX |      |
| $t_{pd}$  | A, B, or C      | Y              | $C_L = 50 \text{ pF}$ |                    | 9.9 | 17.5 | 1            | 21  | ns   |

### 5.7 Switching Characteristics, $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$

over recommended operating free-air temperature range (unless otherwise noted) (see [Load Circuit and Voltage Waveforms](#))

| PARAMETER | FROM<br>(INPUT) | TO<br>(OUTPUT) | LOAD<br>CAPACITANCE   | $T_A = 25^\circ C$ |     |      | SN74LV11A-Q1 |     | UNIT |
|-----------|-----------------|----------------|-----------------------|--------------------|-----|------|--------------|-----|------|
|           |                 |                |                       | MIN                | TYP | MAX  | MIN          | MAX |      |
| $t_{pd}$  | A, B, or C      | Y              | $C_L = 50 \text{ pF}$ |                    | 7.2 | 12.3 | 1            | 14  | ns   |

## 5.8 Switching Characteristics, $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$

over recommended operating free-air temperature range (unless otherwise noted) (see [Load Circuit and Voltage Waveforms](#))

| PARAMETER | FROM<br>(INPUT) | TO<br>(OUTPUT) | LOAD<br>CAPACITANCE  | $T_A = 25^\circ\text{C}$ |     |     | SN74LV11A-Q1 |     | UNIT |
|-----------|-----------------|----------------|----------------------|--------------------------|-----|-----|--------------|-----|------|
|           |                 |                |                      | MIN                      | TYP | MAX | MIN          | MAX |      |
| $t_{pd}$  | A, B, or C      | Y              | $C_L = 50\text{ pF}$ |                          | 5.4 | 7.9 | 1            | 9   | ns   |

## 5.9 Noise Characteristics

$V_{CC} = 3.3\text{ V}$ ,  $C_L = 50\text{ pF}$ ,  $T_A = 25^\circ\text{C}$ <sup>(1)</sup>

| PARAMETER   |                                        | MIN  | TYP | MAX   | UNIT |
|-------------|----------------------------------------|------|-----|-------|------|
| $V_{OL(P)}$ | Quiet output, maximum dynamic $V_{OL}$ |      | 0.2 | 0.8   | V    |
| $V_{OL(V)}$ | Quiet output, minimum dynamic $V_{OL}$ |      | 0   | - 0.8 | V    |
| $V_{OH(V)}$ | Quiet output, minimum dynamic $V_{OH}$ |      | 3.2 |       | V    |
| $V_{IH(D)}$ | High-level dynamic input voltage       | 2.31 |     |       | V    |
| $V_{IL(D)}$ | Low-level dynamic input voltage        |      |     | 0.99  | V    |

(1) Characteristics are for surface-mount packages only.

## 5.10 Operating Characteristics

$T_A = 25^\circ\text{C}$

| PARAMETER |                               | TEST CONDITIONS      |                     | $V_{CC}$ | TYP  | UNIT |
|-----------|-------------------------------|----------------------|---------------------|----------|------|------|
| $C_{pd}$  | Power dissipation capacitance | $C_L = 50\text{ pF}$ | $f = 10\text{ MHz}$ | 3.3 V    | 13.9 | pF   |
|           |                               |                      |                     | 5 V      | 15.4 |      |

## 6 Parameter Measurement Information

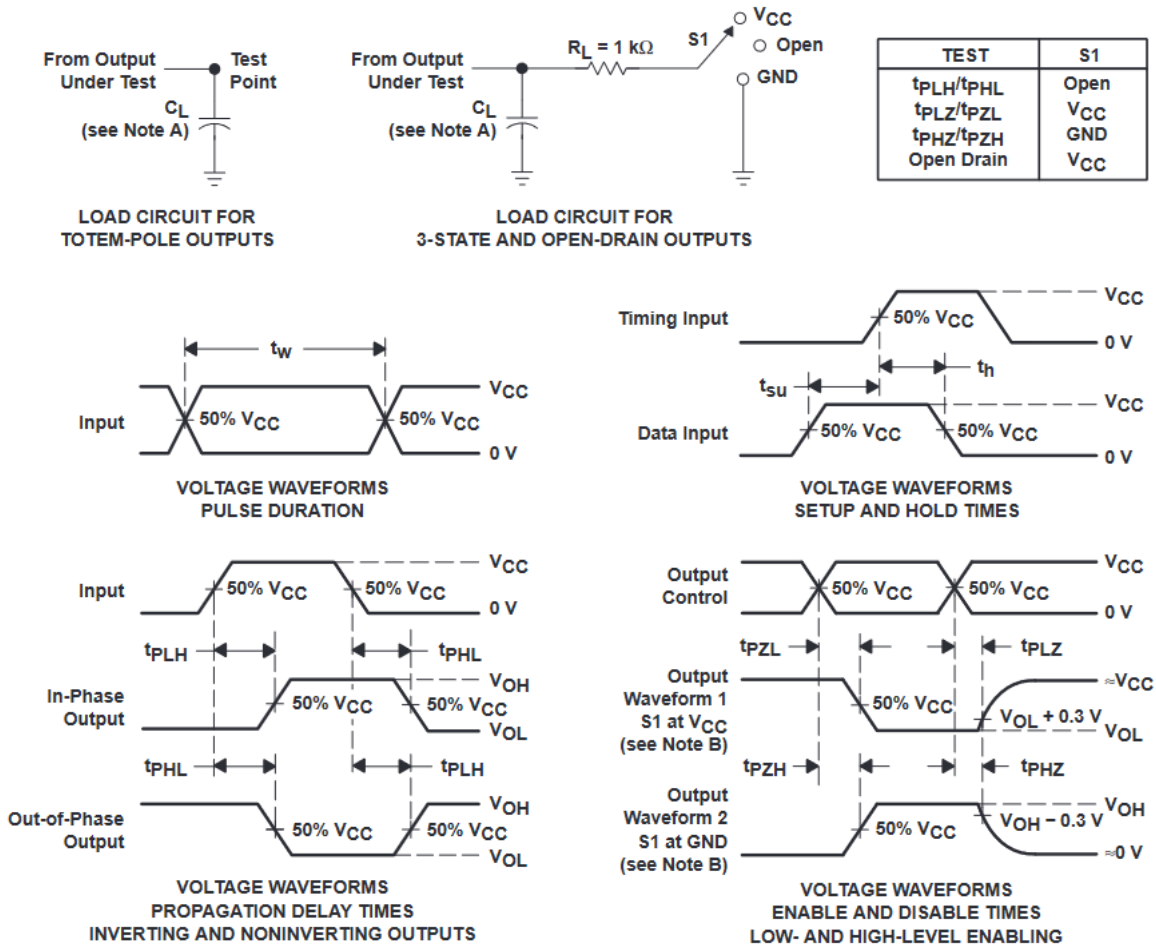


图 6-1. Load Circuit and Voltage Waveforms

- A.  $C_L$  includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 1\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 3\text{ ns}$ ,  $t_f \leq 3\text{ ns}$ .
- D. The outputs are measured one at a time, with one input transition per measurement.
- E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
- F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
- G.  $t_{PHL}$  and  $t_{PLH}$  are the same as  $t_{pd}$ .
- H. All parameters and waveforms are not applicable to all devices.

## 7 Detailed Description

### 7.1 Overview

These triple 3-input positive-AND gate is designed for 2-V to 5.5-V  $V_{CC}$  operation. The SN74LV11A-Q1 device performs the Boolean function  $Y = \overline{A + B + C}$  in positive logic. This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

### 7.2 Functional Block Diagram

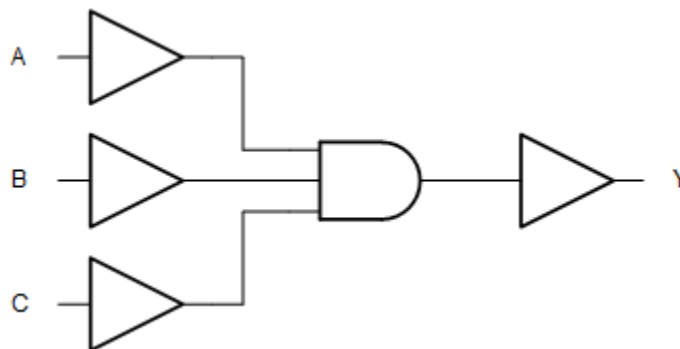


图 7-1. logic diagram, each gate (positive logic)

### 7.3 Device Functional Modes

表 7-1. FUNCTION TABLE  
(each gate)

| INPUT <sup>(1)</sup> |   |   | OUTPUT <sup>(2)</sup> |
|----------------------|---|---|-----------------------|
| A                    | B | C | Y                     |
| H                    | H | H | H                     |
| L                    | X | X | L                     |
| X                    | L | X | L                     |
| X                    | X | L | L                     |

(1) H = High Voltage Level, L = Low Voltage Level, X = Don't Care

(2) H = Driving High, L = Driving Low

## 8 Device and Documentation Support

TI offers an extensive line of development tools. Tools and software to evaluate the performance of the device, generate code, and develop solutions are listed below.

### 8.1 Documentation Support (Analog)

#### 8.1.1 Related Documentation

**表 8-1. Related Links**

| PARTS        | PRODUCT FOLDER             | SAMPLE & BUY               | TECHNICAL DOCUMENTS        | TOOLS & SOFTWARE           | SUPPORT & COMMUNITY        |
|--------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|
| SN74LV11A-Q1 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |

#### 8.2 接收文档更新通知

要接收文档更新通知，请导航至 [ti.com](http://ti.com) 上的器件产品文件夹。点击 [订阅更新](#) 进行注册，即可每周接收产品信息更改摘要。有关更改的详细信息，请查看任何已修订文档中包含的修订历史记录。

#### 8.3 支持资源

[TI E2E™ 支持论坛](#) 是工程师的重要参考资料，可直接从专家获得快速、经过验证的解答和设计帮助。搜索现有解答或提出自己的问题可获得所需的快速设计帮助。

链接的内容由各个贡献者“按原样”提供。这些内容并不构成 TI 技术规范，并且不一定反映 TI 的观点；请参阅 TI 的 [《使用条款》](#)。

#### 8.4 Trademarks

TI E2E™ is a trademark of Texas Instruments.

所有商标均为其各自所有者的财产。

#### 8.5 静电放电警告



静电放电 (ESD) 会损坏这个集成电路。德州仪器 (TI) 建议通过适当的预防措施处理所有集成电路。如果不遵守正确的处理和安装程序，可能会损坏集成电路。

ESD 的损坏小至导致微小的性能降级，大至整个器件故障。精密的集成电路可能更容易受到损坏，这是因为非常细微的参数更改都可能会导致器件与其发布的规格不相符。

#### 8.6 术语表

[TI 术语表](#)      本术语表列出并解释了术语、首字母缩略词和定义。

## 9 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable part number             | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-----------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">SN74LV11ATPWRG4Q1</a> | Active        | Production           | TSSOP (PW)   14 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 105   | LV11AT              |
| SN74LV11ATPWRG4Q1.A               | Active        | Production           | TSSOP (PW)   14 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 105   | LV11AT              |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

**Important Information and Disclaimer:**The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

### OTHER QUALIFIED VERSIONS OF SN74LV11A-Q1 :

- Catalog : [SN74LV11A](#)

- Enhanced Product : [SN74LV11A-EP](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Enhanced Product - Supports Defense, Aerospace and Medical Applications

## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device           | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74LV11ATPWG4Q1 | TSSOP        | PW              | 14   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |
| SN74LV11ATPWG4Q1 | TSSOP        | PW              | 14   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

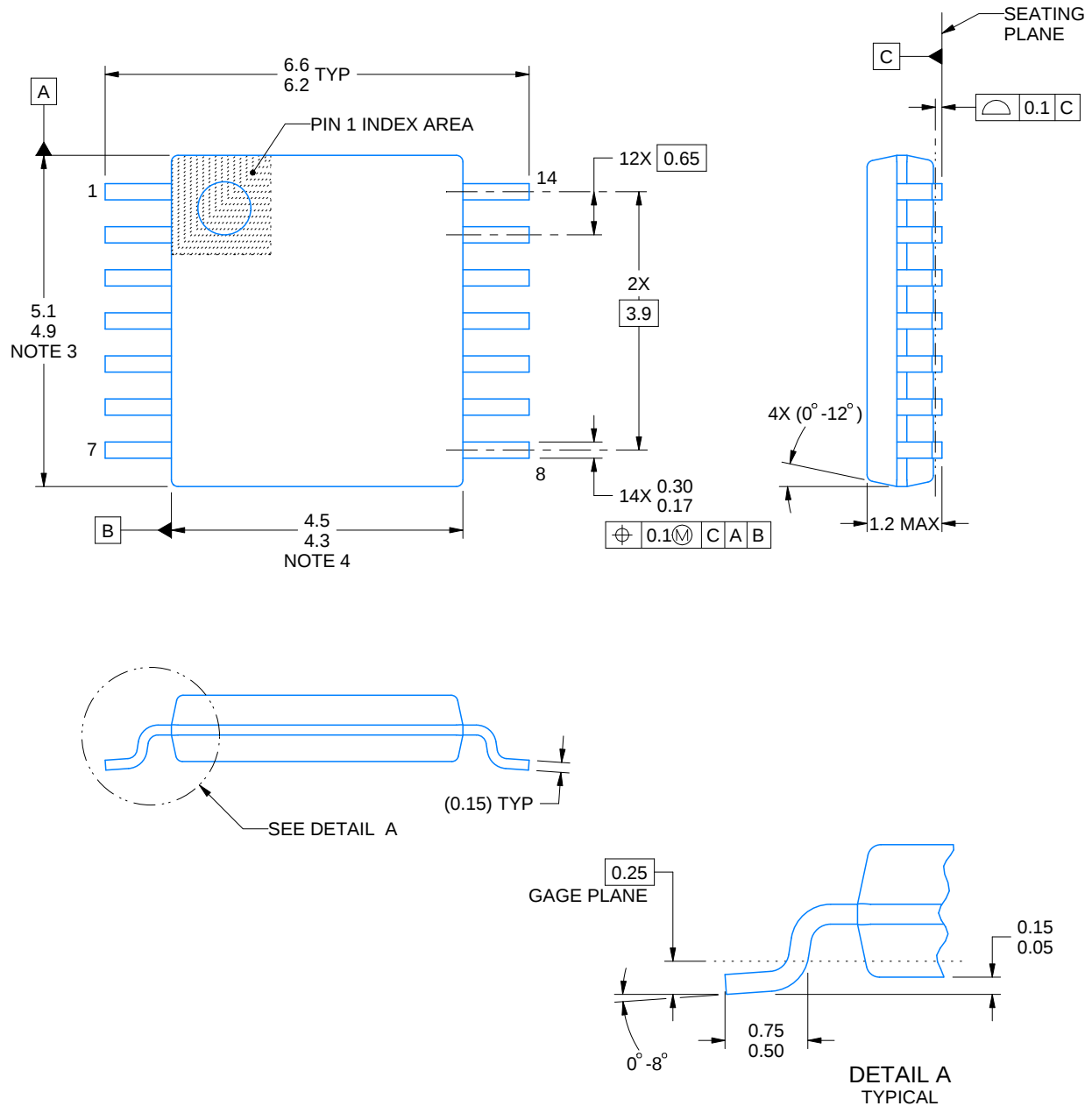
| Device             | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LV11ATPW RG4Q1 | TSSOP        | PW              | 14   | 2000 | 353.0       | 353.0      | 32.0        |
| SN74LV11ATPW RG4Q1 | TSSOP        | PW              | 14   | 2000 | 356.0       | 356.0      | 35.0        |

**PW0014A**

## PACKAGE OUTLINE

**TSSOP - 1.2 mm max height**

SMALL OUTLINE PACKAGE



4220202/B 12/2023

NOTES:

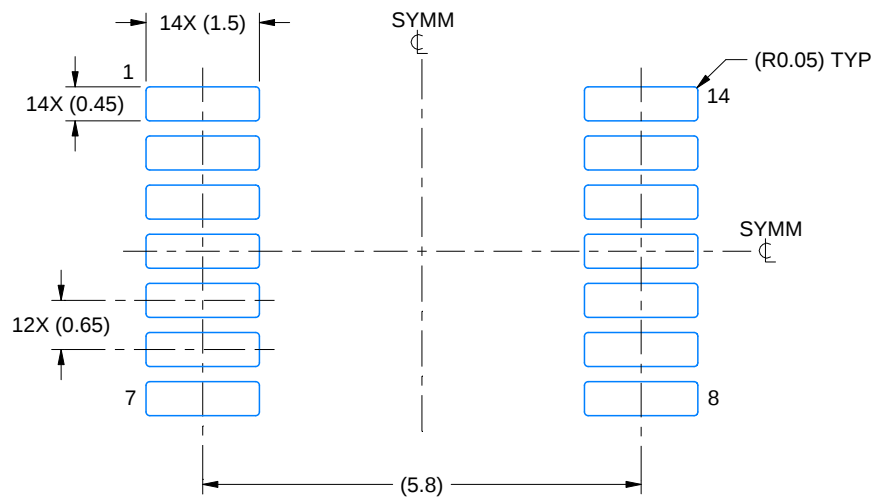
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.

# EXAMPLE BOARD LAYOUT

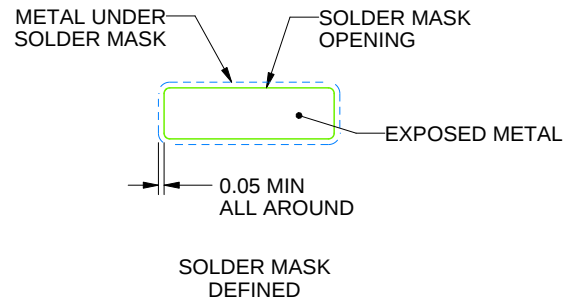
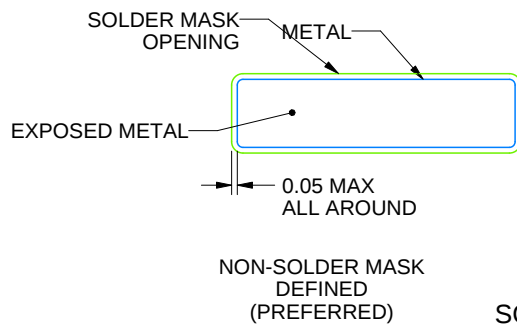
PW0014A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



SOLDER MASK DETAILS

4220202/B 12/2023

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

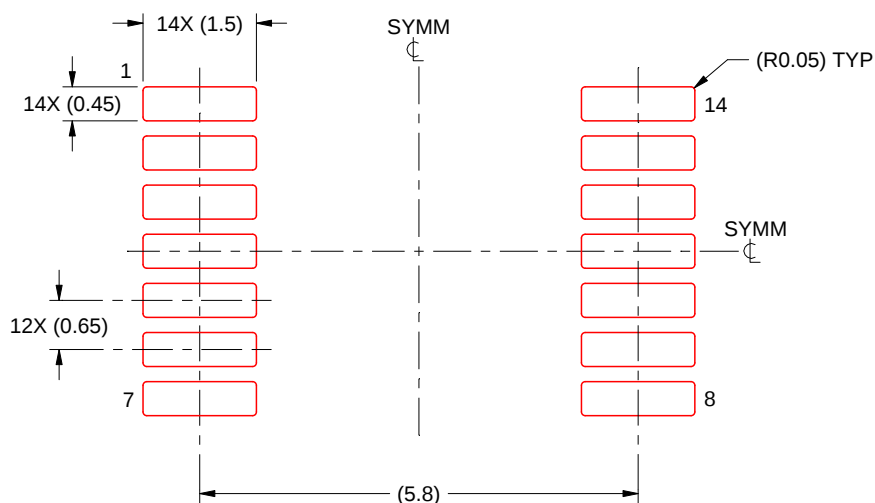
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

PW0014A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

4220202/B 12/2023

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

## 重要通知和免责声明

TI“按原样”提供技术和可靠性数据（包括数据表）、设计资源（包括参考设计）、应用或其他设计建议、网络工具、安全信息和其他资源，不保证没有瑕疵且不做任何明示或暗示的担保，包括但不限于对适销性、某特定用途方面的适用性或不侵犯任何第三方知识产权的暗示担保。

这些资源可供使用 TI 产品进行设计的熟练开发人员使用。您将自行承担以下全部责任：(1) 针对您的应用选择合适的 TI 产品，(2) 设计、验证并测试您的应用，(3) 确保您的应用满足相应标准以及任何其他功能安全、信息安全、监管或其他要求。

这些资源如有变更，恕不另行通知。TI 授权您仅可将这些资源用于研发本资源所述的 TI 产品的相关应用。严禁以其他方式对这些资源进行复制或展示。您无权使用任何其他 TI 知识产权或任何第三方知识产权。您应全额赔偿因在这些资源的使用中对 TI 及其代表造成的任何索赔、损害、成本、损失和债务，TI 对此概不负责。

TI 提供的产品受 [TI 的销售条款](#) 或 [ti.com](#) 上其他适用条款/TI 产品随附的其他适用条款的约束。TI 提供这些资源并不会扩展或以其他方式更改 TI 针对 TI 产品发布的适用的担保或担保免责声明。

TI 反对并拒绝您可能提出的任何其他或不同的条款。

邮寄地址：Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
版权所有 © 2025，德州仪器 (TI) 公司